

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:

John L. Klocke and Linlin Chen

Application No. 10/688,420

Filed: October 16, 2003

Confirmation No. 2239

For: ELECTROPLATING COMPOSITIONS
AND METHODS FOR
ELECTROPLATING

Examiner: Edna Wong

Art Unit: 1753

Attorney Reference No. 6884-65576-01

CERTIFICATE OF MAILING

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PURSUANT TO 37 C.F.R. § 1.97(c)

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Copies of United States patents and United States published patent applications do not have to be provided to the Patent Office (37 C.F.R. 1.98(a)(2)(ii)). Copies of unpublished U.S. applications do not have to be provided, as long as the application is available on PAIR, as this requirement of 37 C.F.R. § 1.98(a)(2)(iii) has been waived by the United States Patent and Trademark Office pursuant to the Official Gazette Notice on October 19, 2004 (1287 OG 163). Applicants will provide copies of such patents or applications upon request.

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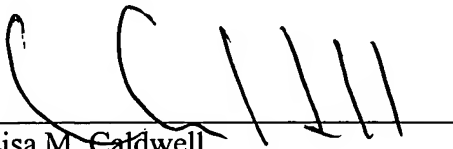
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Respectfully submitted,

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT

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Attorney Docket Number	6884-65576-01
Application Number	10/688,420
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First Named Inventor	John L. Klocke
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Examiner Name	Edna Wong

U.S. PATENT DOCUMENTS

Copies of U.S. Patent documents do not need to be provided, unless requested by the Patent and Trademark Office. For patents, provide the patent number and the issue date. For published U.S. applications, provide the publication number and the publication date. For unpublished pending patent applications, provide the application number and the filing date.

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FOREIGN PATENT DOCUMENTS

Examiner's Initials*	Cite No. (optional)	Country	Number	Publication Date	Name of Applicant or Patentee

OTHER DOCUMENTS

Examiner's Initials*	Cite No. (optional)	
		International Search Report from International Application No. PCT/US04/33229
		Written Opinion from International Application No. PCT/US04/33229

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SIGNATURE:DATE
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